

Features

- Low On-resistance and Low Conduction Loss
- Super Junction technology for High Voltage Application
- Ultra Low Gate Charge Cause Lower Driving Requirement
- · Moisture Sensitivity Level 1
- Epoxy Meets UL 94 V-0 Flammability Rating
- Halogen Free."Green "Device(Note 1)
- Lead Free Finish/RoHS Compliant. "P" Suffix Designates RoHS Compliant. See Ordering Information

Maximum Ratings

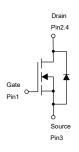
- Operating Junction Temperature Range: -55°C to +150°C
- Storage Temperature Range: -55°C to +150°C
- Thermal Resistance Junction to Ambient, Max^(Note 2): 50°C/W
- Thermal Resistance Junction to Case, Max: 2.1°C/W

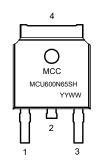
Parameter		Symbol	Value	Unit	
Drain-Source Voltage		V _{DS}	650	V	
Gate-Source Volltage		V _{GS}	±30	V	
Continuous Drain Current	T _C =25°C	- I _D	6.6	A	
	T _C =100°C		4.2		
Pulsed Drain Current ^(Note 3)		I _{DM}	26.4	Α	
Total Power Dissipation, T _C =25°C		P _D	59.5	W	
Single Avalanche Energy ^(Note 4)		E _{AS}	34	mJ	

Note:

- 1. Halogen free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 3. Repetitive rating; pulse width limited by max. junction temperature.
- 4. Starting T_J=25°C, V_{DD}=50V,I_{AS}=2.4A.

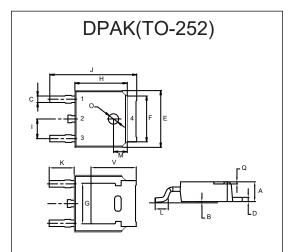
Internal Structure and Marking Code





Device Code: MCU600N65SH Date Code: YYWW (Year & Week)

N-CHANNEL Super-Junction Power MOSFET



DIMENSIONS						
DIM	INCHES		MM		NOTE	
DIIVI	MIN	MAX	MIN	MAX	NOTE	
Α	0.087	0.094	2.20	2.40		
В	0.000	0.005	0.00	0.13		
С	0.026	0.034	0.66	0.86		
D	0.018	0.023	0.46	0.58		
Е	0.256	0.264	6.50	6.70		
F	0.201	0.215	5.10	5.46		
G	0.1	90	4.83		TYP.	
Н	0.236	0.244	6.00	6.20		
ı	0.086	0.094	2.18	2.39		
J	0.386	0.409	9.80	10.40		
K	0.1	14	2.90		TYP.	
L	0.055	0.067	1.40	1.70		
М	0.0	63	1.60		TYP.	
0	0.043	0.051	1.10	1.30		
Q	0.000	0.012	0.00	0.30		
V	0.2	11	5.35		TYP.	

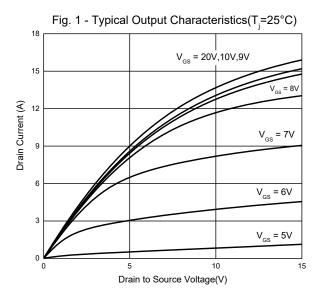


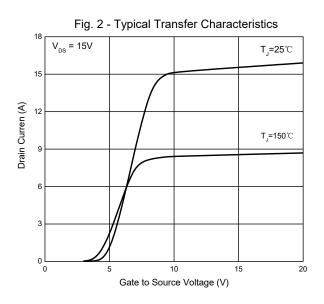
Electrical Characteristics ($T_J = 25\,\text{C}$ unless otherwise specified)

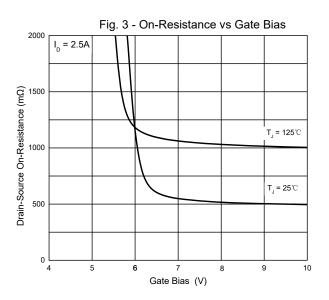
Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit	
Static Characteristics							
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} =0V, I _D =1mA	650			V	
Gate-Source Leakage Current	I _{GSS}	V _{DS} =0V, V _{GS} =±30V			±100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =650V, V _{GS} =0V			1	μA	
Gate-Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}$, $I_{D}=0.5$ mA	2.5	3.7	4.5	V	
Drain-Source On-Resistance	R _{DS(on)}	V _{GS} =10V, I _D =2.5A		511	600	mΩ	
Gate Resistance	R_{g}	f=1MHz, open drain		7		Ω	
Diode Characteristics							
Diode Forward Voltage	V_{SD}	V _{GS} =0V, I _S =2.5A			1.2	V	
Reverse Recovery Time	t _{rr}			150		ns	
Reverse Recovery Charge	Q _{rr}	V _R =325V, I _F =2.5A dI _F /dt=100A/µs		1120		nC	
Peak Reverse Recovery Current	I _{rrm}			16		Α	
Dynamic Characteristics							
Input Capacitance	C _{iss}			411			
Output Capacitance	C _{oss}	V_{DS} =100V, V_{GS} =0V, f=250kHz		21		_	
Output capacitance - energy related	C _{o(er)}	\/ -0 to 400\/ \/ -0\/		19		pF	
Output capacitance - time related	C _{o(tr)}	V_{DS} =0 to 400V, V_{GS} =0V		120			
Total Gate Charge	Q_g			13			
Gate-Source Charge	Q_{gs}	V _{DS} =325V, V _{GS} =10V, I _D =2.5A		3		nC	
Gate-Drain Charge	Q_{gd}			7			
Turn-On Delay Time	t _{d(on)}			17			
Turn-On Rise Time	t _r	V _{DD} =325V, V _{GS} =10V		18		,	
Turn-Off Delay Time	$t_{d(off)}$	$R_{G}=2.7\Omega, I_{D}=2.5A$		26		ns	
Turn-Off Fall Time	t _f	-		50			

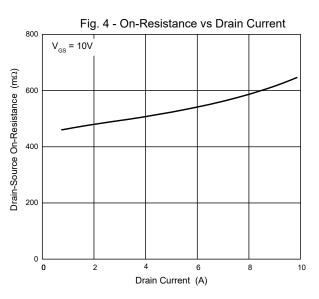


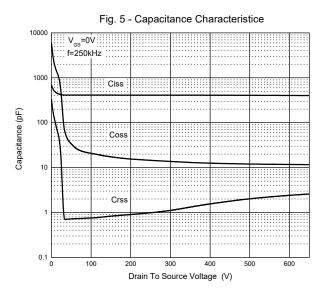
Typical Characteristics (T_J=25 ℃ unless otherwise specified)

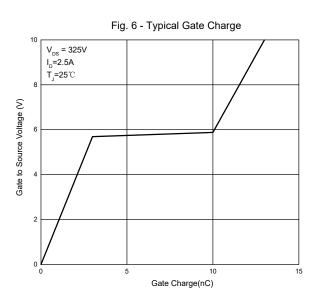






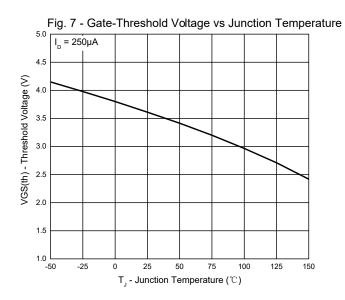


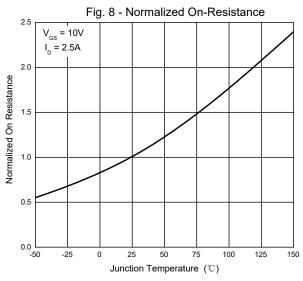


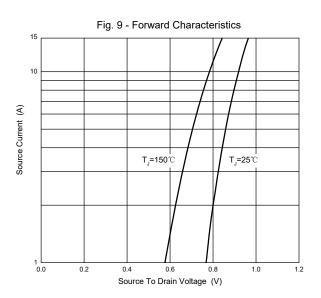


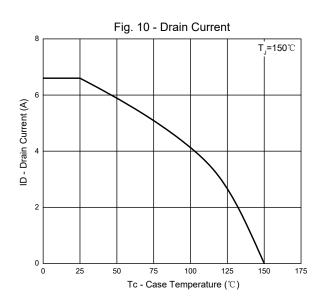


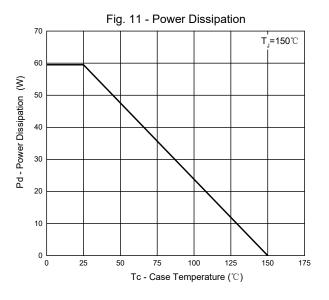
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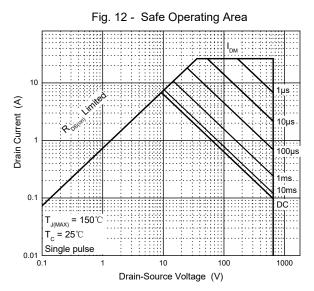














Typical Characteristics (T_J=25 ℃ unless otherwise specified)

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Ordering Information

Device	Packing
Part Number-TP	Tape&Reel: 2.5Kpcs/Reel

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